



843.40341CX1

TFW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Y. SAITOH et al  
Serial No.: 10/764,539  
Filed: January 27, 2004  
For: SEMICONDUCTOR WAFER, SEMICONDUCTOR CHIP, AND  
MANUFACTURING METHOD OF SEMICONDUCTOR CHIP  
Group: 2818  
Examiner: T. NGUYEN

**AMENDMENT**

**MS: AMENDMENTS**

Commissioner For Patents  
POB 1450  
Alexandria, VA 22313-1450

October 29, 2004

Sir:

In response to the Office Action dated July 29, 2004, please amend the above-identified application as listed below and as set forth on the following pages:

**Amendments to the Claims;**

**Remarks** are included following the Amendment.